**2019 Engineering Fall Summit**

October 9-10, 2019

The Westin Poinsett, Greenville, SC

**Preliminary Program**

|  |  |  |
| --- | --- | --- |
| **Date** | **Interest Category** | **Committee Meeting or Event** |
|  |  |  |
| **Tues., October 8** |  |  |
| 4:00 – 5:00 pm |  | Working Group activities (as needed)  New attendee orientation |
|  |  |  |
| **Wed., October 9** |  |  |
| 9:00am - 10:15am | All Participants | S-1 Committee Users' Group/General Session |
|  |  | P-2.2 Paper, Film, Mica & Wet Electrolytic Capacitors |
|  |  | P-3 Inductive Components |
| 10:15am -10:30am |  | Break |
|  |  |  |
| 10:30am -11:00am |  | Procedural training & updates EP-20 Revision |
|  |  |  |
| 11:00am - Noon | Tantalum Capacitors | P-2.5 Solid Electrolytic Capacitors |
|  | Ceramic Capacitors | P-2.1. Ceramic Capacitors |
|  |  |  |
| 12:00 - 1:00pm | All Participants | Lunch |
|  |  |  |
| 1:00pm – 1:30pm | All Participants | iNEMI Roadmap workshop |
|  |  |  |
| 1:30pm - 2:00pm | Resistors and IPDs | P-1 Resistive Devices and P-10 Integrated Passive Devices |
|  |  |  |
|  |  |  |
| 2:00pm - 4:00pm | Soldering and Lead-Free | STC-Soldering Technology Committee |
|  |  |  |
|  |  |  |
| 4:00pm - 4:30pm | All Chairs & Interested | EIA Standards Council (All Chair's Meeting) |
|  |  |  |
| 5:00pm – 6:00pm | All | Reception |
|  |  |  |
|  |  |  |
|  |  |  |
| **Thur., October 10** |  |  |
| 8:00am - Noon | Automated Component Handling, Tape & Reeled Product and Carrier Trays | ACH Automated Component Handling Committee |
|  |  |  |
|  |  |  |